DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the inventor (if plura the invention enti	original, first and sole invent I names are listed below) of th itled	or (if only one name is to subject matter which is	listed below) or an original, f is claimed and for which a pa	irst and joint tent is sought on
OPTICA	AL FIBER ARRAY A	ND METHOD FOR	ITS MANUFACTUR	Ε
	of which is attached bossto up	lace the following is the	ncked	
•	of which is attached hereto un as United States Applica			n Number
	as United States Application (if applicable).	ation Number or	1C1 menanoiai appireano	
I hereby state tha	t I have reviewed and understanded by any amendment refer		above-identified specification,	, including the
,	e duty to disclose information		tentability as defined in Title	37, Code of
application(s) for	reign priority benefits under I patent or inventor's certificat r's certificate having a filing o	e listed below and have	also identified below any for	eign application for
(List prior foreign applications. See	274871/2002	JAPAN	20/09/2002	X Yes ☐ No
note A below)	(Number)	(Country)	(Day/Month/Year Filed)	
	, ,	·		□V ₂₂ □Na
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(14dilloct)	(Country)	(52)	
				Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	
		•		☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B belo	w) See attacl	hed list for additional pr	ior foreign applications	
and, insofar as application in the	the benefit under Title 35, Unite subject matter of each of the manner provided by the firm information which is materizate away available between the first application.	the claims of this applies the paragraph of Title 3 als to patentability as de	lication is not disclosed in the s. United States Code, § 11 fined in Title 37, Code of F	ne prior United States 2, I acknowledge the ederal Regulations, §
			Stat	tus
(List prior U.S. Applications)			□ Patented □ Oan	ding Abandoned
- ppromons,	(Application Serial No.)	(Filing Date)		umg [_] Abandoned
		.	П.	
-	(Application Serial No.)	(Filing Date)	Patented Pen	ding
	(Application Serial 140.)	(i ning Date)		
_			Patented 🔲 Pen	ding 🗌 Abandoned
	(Application Serial No.)	(Filing Date)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



23850
PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



2383U
PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's signature		Date	
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Full name of fifth in Inventor's signature	ventor (given name, family name)	Date	
Residence		Citizenship	